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Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	-30					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.019					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.030					
Q <sub>g</sub> typ. (nC)	13.5					
I <sub>D</sub> (A) <sup>a</sup>	-16					
Configuration	Single					

#### **FEATURES**

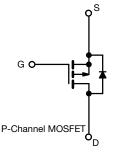
- TrenchFET® Gen III p-channel power MOSFET
- 100 % R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- Adapter switch
- · Load switch
- DC/DC converters
- · High speed switching
- Power management in battery-operated, mobile and wearable devices



ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSA35DN-T1-GE3

ABSOLUTE MAXIMUM RATING	13 (1A - 23 O, 0			ı	
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage		V <sub>GS</sub>	± 20	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-16 <sup>a</sup>		
	T <sub>C</sub> = 70 °C		-16 <sup>a</sup>		
	T <sub>A</sub> =25 °C	I <sub>D</sub>	-10 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		-8 b, c	A	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	-50		
	T <sub>C</sub> = 25 °C	,	-16 <sup>a</sup>		
Continuous source-drain diode current	T <sub>A</sub> = 70 °C	I <sub>S</sub>	-2.6 b, c		
	T <sub>C</sub> = 25 °C		24		
Maximum power dissipation	T <sub>C</sub> = 70 °C		15	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.2 b, c	VV	
	T <sub>A</sub> = 70 °C		2.1 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) e, f			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	31	39	°C/W	
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	4.2	5.2	]	

### Notes

- a. Package limited, T<sub>C</sub> = 25 °
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. Maximum under steady state conditions is 81 °C/W
- e. See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- f. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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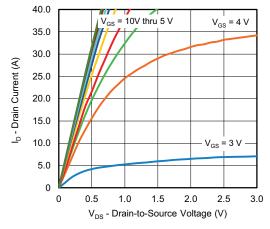
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-25	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.5	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1	-	-2.2	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zana anta valta an alumin avuunnt		V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V	-	-	-1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = 10 \text{ V}$	-10	-	-	Α
Due in account on atota accidence 2	Б	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -9 A	-	0.015	0.019	Ω
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -7 \text{ A}$	-	0.023	0.030	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -9 \text{ A}$	-	25	-	S
Dynamic <sup>b</sup>					•	
Input capacitance	C <sub>iss</sub>		-	1500	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	180	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	150	-	
Talal asta ala ara	Qg	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	-	28	28 42	
Total gate charge		$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	13.5	21	nC
Gate-source charge	Q <sub>gs</sub>	V 45VV 45VV 5A	-	4.4	-	
Gate-drain charge	Q <sub>gd</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	4.3	-	1
Gate resistance	$R_{g}$	f = 1 MHz	0.6	3.3	6.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	26	50	
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_L = 15 \Omega, I_D \cong -1 \text{ A},$	-	30	60	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	21	40	
Fall time	t <sub>f</sub>		-	16	30	1
Turn-on delay time	t <sub>d(on)</sub>		-	9	20	ns -
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_1 = 15 \Omega, I_D \cong -1 \text{ A},$	-	18	35	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	23	45	
Fall time	t <sub>f</sub>		-	15	30	
Drain-Source Body Diode Characteristic	cs				•	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-16	^
Pulse diode forward current	I <sub>SM</sub>		-	-	-50	A
Body diode voltage	$V_{SD}$	$I_S = -5 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.82	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	20	40	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	10	20	nC
Reverse recovery fall time	ta	T <sub>J</sub> = 25 °C	-	10	-	
Reverse recovery rise time	t <sub>b</sub>		-	10	_	ns

#### Notes

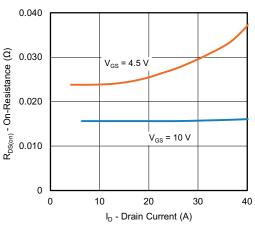
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

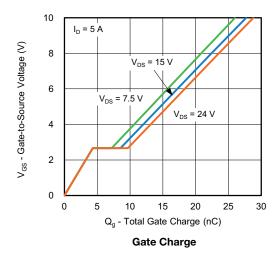


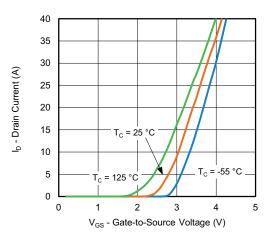


#### **Output Characteristics**

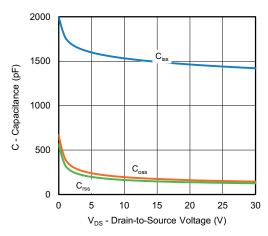


On-Resistance vs. Drain Current and Gate Voltage

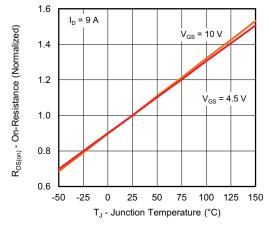




**Transfer Characteristics** 

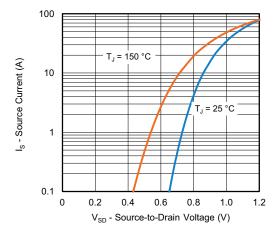


Capacitance

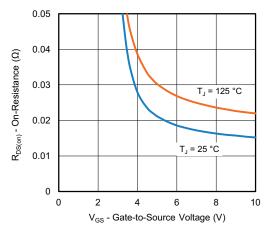


On-Resistance vs. Junction Temperature

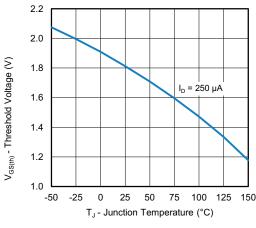




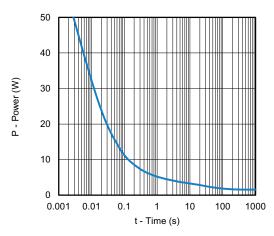
Source-Drain Diode Forward Voltage



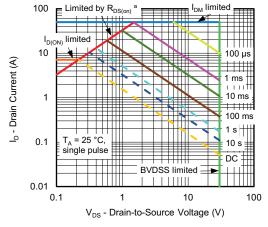
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

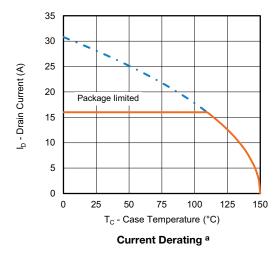


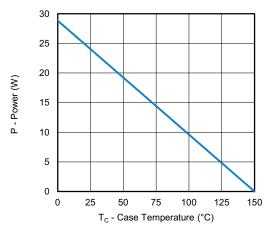
Safe Operating Area, Junction-to-Ambient

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





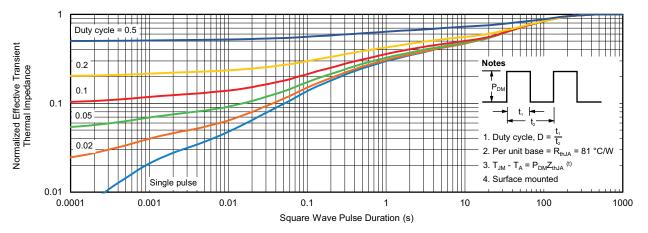


Power, Junction-to-Foot

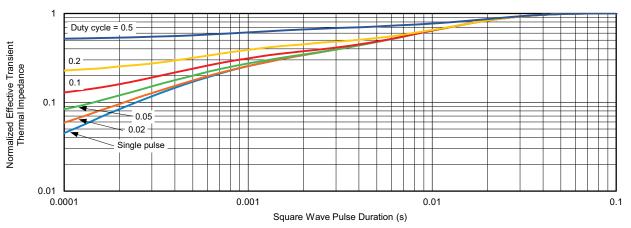
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

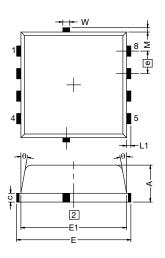


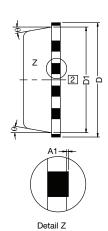
Normalized Thermal Transient Impedance, Junction-to-Case

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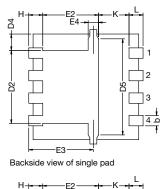
# PowerPAK® 1212-8, (Single / Dual)

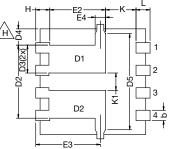




#### Notes

- 1. Inch will govern
- 2 Dimensions exclusive of mold gate burrs
- Dimensions exclusive of mold flash and cutting burrs





Backside view of dual pad

DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.97	1.04	1.12	0.038	0.041	0.044	
A1	0.00	-	0.05	0.000	-	0.002	
b	0.23	0.30	0.41	0.009	0.012	0.016	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.95	3.05	3.15	0.116	0.120	0.124	
D2	1.98	2.11	2.24	0.078	0.083	0.088	
D3	0.48	-	0.89	0.019	=	0.035	
D4	0.47 typ. 0.0185 typ			0.0185 typ			
D5		2.3 typ.		0.090 typ			
Е	3.20	3.30	3.40	0.126	0.130	0.134	
E1	2.95	3.05	3.15	0.116	0.120	0.124	
E2	1.47	1.60	1.73	0.058	0.063	0.068	
E3	1.75	1.85	1.98	0.069	0.073	0.078	
E4		0.034 typ.			0.013 typ.		
е		0.65 BSC			0.026 BSC		
K		0.86 typ.			0.034 typ.		
K1	0.35	-	-	0.014	-	-	
Н	0.30	0.41	0.51	0.012	0.016	0.020	
L	0.30	0.43	0.56	0.012	0.017	0.022	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ.			0.005 typ.			

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# RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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